



Industrial Internet of Things (IIoT): New Directions, Challenges and Applications

Guest Editors:

Prof. Dr. Guangjie Han

Information Department, Hohai University, Changzhou 213022, China

Dr. Chuan Lin

School of Software, Northeastern University, Shenyang 110819, China

Deadline for manuscript submissions:

closed (31 January 2025)

Message from the Guest Editors

The Industrial Internet of Things (IIoT) is an important part of Industry 4.0. The Industrial Internet of Things continuously integrates various acquisition or control sensors or controllers with sensing and monitoring capabilities, as well as ubiquitous technology, mobile communication, intelligent analysis, and other technologies into all aspects of the industrial production process, thereby greatly improving manufacturing efficiency and product quality, reducing product cost and resource consumption, and finally realizing the promotion of traditional industry to a new stage of intelligence. From the application form, the application of the Industrial Internet of Things has the characteristics of real-time, automation, embedded (software), security, and information interoperability. This Special Issue aims to address the aforementioned questions by inviting scholarly contributions covering recent advances in the Industrial Internet of Things and its applications. We welcome original research articles covering new applications, challenges, and developments in IIoT, as well as IIoT application papers with novel ideas.





an Open Access Journal by MDPI

Editor-in-Chief

Prof. Dr. Giulio Nicola Cerullo
Dipartimento di Fisica,
Politecnico di Milano, Piazza L.
da Vinci 32, 20133 Milano, Italy

Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal *Applied Sciences* has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

Author Benefits

Open Access: free for readers, with article processing charges (APC) paid by authors or their institutions.

High Visibility: indexed within Scopus, SCIE (Web of Science), Ei Compendex, Inspec, Embase, CAPlus / SciFinder, and other databases.

Journal Rank: JCR - Q2 (Engineering, Multidisciplinary) / CiteScore - Q1 (General Engineering)

Contact Us

Applied Sciences Editorial Office
MDPI, Grosspeteranlage 5
4052 Basel, Switzerland

Tel: +41 61 683 77 34
www.mdpi.com

mdpi.com/journal/applsci
applsci@mdpi.com
[X@Applsci](https://twitter.com/AtApplsci)